

# PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT							
NATURE OF CONVEYANCE:	ASSIGNMENT							
CONVEYING PARTY DATA								
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Sen-Huang Tang</td> <td>06/10/2007</td> </tr> <tr> <td>Wen-Tsai Liao</td> <td>06/10/2007</td> </tr> </tbody> </table>		Name	Execution Date	Sen-Huang Tang	06/10/2007	Wen-Tsai Liao	06/10/2007	
Name	Execution Date							
Sen-Huang Tang	06/10/2007							
Wen-Tsai Liao	06/10/2007							
RECEIVING PARTY DATA								
Name:	Realtek Semiconductor Corp.							
Street Address:	2 Innovation Rd. II, Science Park							
City:	HsinChu							
State/Country:	TAIWAN							
PROPERTY NUMBERS Total: 1								
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11763458</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11763458			
Property Type	Number							
Application Number:	11763458							
CORRESPONDENCE DATA								
<p>Fax Number: (703)997-4517</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 3027291562</p> <p>Email: Patent.admin.uspto.cr@naipo.com</p> <p>Correspondent Name: WINSTON HSU</p> <p>Address Line 1: P.O.BOX 506</p> <p>Address Line 4: Merrifield, VIRGINIA 22116</p>								
ATTORNEY DOCKET NUMBER:	REAP0273USA							
NAME OF SUBMITTER:	WINSTON HSU							
<p>Total Attachments: 2</p> <p>source=reap0273usa0_a1_1_np005#page1.tif</p> <p>source=reap0273usa0_a1_1_np005#page2.tif</p>								

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PATENT  
REEL: 019433 FRAME: 0192

**ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

**ASSIGNOR(S) (Inventors):**

Name: Sen-Huang Tang Nationality: R.O.C.

Name: Wen-Tsai Liao Nationality: R.O.C.

Hereby sells, assigns and transfers to

**ASSIGNEE(S):**

Name: Realtek Semiconductor Corp.

Address: 2 Innovation Rd. II, Science Park, HsinChu 30076, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

**"METHOD AND APPARATUS FOR PROCESSING VIDEO DATA"**

Which is found in :

- (a) + U.S. patent application executed on even date  
(b) \_\_\_\_\_ U.S. patent application executed on \_\_\_\_\_  
(c) \_\_\_\_\_ U.S. application serial no. \_\_\_\_\_  
(d) \_\_\_\_\_ patent no. \_\_\_\_\_ issued \_\_\_\_\_

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

JUN 10 2007

IN WITNESS WHEREOF, We have hereunto set hand and seal this \_\_\_\_\_ (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Signature of INVENTOR

Sen-Huang Tang

Sen-Huang Tang

Wen-Tsai Liao

Wen-Tsai Liao